

## **EQUIPMENT ENGINEER**

## **Responsibilities:**

- Carry out equipment maintenance activities for wafer bumping equipment
- Responsible to reduce equipment downtime and maximize machine availability
- Monitor equipment OEE, MTBA, MTBF and spare parts planning
- Involve in new equipment installation and setup
- Establish or improve machine preventive maintenance checklist and equipment FMEA
- Organize preventative maintenance and repair of production equipment and optimize maintenance schedules
- Work on machine parameters, SECS GEM, FDC and system setup
- Verification and analysis on defective part to determine the root cause and remedy
- Troubleshoot equipment major problems
- Drive continuous improvement activities on the equipment and manpower needed

## **Requirements:**

- Degree in Electrical / Electronic / Mechatronics / Mechanical Engineering or related Engineering discipline.
- Candidate with experience in equipment maintenance in semiconductor industry is an advantage.
- Fresh graduate are also encouraged to apply.
- Good analytical, communication and report writing skill.

Interested applicants are invited to write-in / email with a comprehensive resume to:

HUMAN RESOURCE DEPARTMENTUNISEM ADVANCED TECHNOLOGIES SDN. BHDNo 1A, Persiaran Pulai Jaya 9,Kawasan Perindustrian Pulai Jaya,31300 Ipoh Perak.Telephone No. :+605-3572800Email :recruiting@unisemgroup.com